

FACILITATING THE SPREAD OF ENCAPSULANT
BETWEEN SURFACES OF ELECTRONIC DEVICES

Abstract of the Disclosure

An electronic device having an extensive narrow
5 passageway may be effectively encapsulated by forming
openings in one or more of the surfaces defining the
encapsulation region. Encapsulation material may then be
injected through these openings to fill a narrow, difficult
to access region between two surfaces being encapsulated.

10 In some cases, the encapsulant may be applied
progressively, starting with a central port and applying
the encapsulant in a radially expanding front through
radially displaced ports.